



PRODUCT DATASHEET



- PLCC8 SMD
- ▶ 3735 1.8t Series
- Cool White / Red / Green / Blue



Compliant



APPLICATIONS:

• LED Display

WRGB

NOM61S09

- Switch Light
- 3C Application
- Decoration Lighting
- Amusement Lighting
- Architecture Lighting
- LED Light Strip

- FEATURES (Cool White/Red/Green/Blue):
- Package: PLCC8 WRGB Top View SMD Package
- Forward Current: 20/20/20/20mA *

3735 1.8t Series

- Forward Voltage (typ.): 3.1/2.2/3.1/3.1V
- Luminous Flux (typ.): 2200/750/1500/370mcd@20mA
- Colour: Cool White/Red/Green/Blue
- CCT/Wavelength: 6000K/622/525/467nm
- Viewing angle: 120°
- Materials:
 - Die: InGaN/AlGaInP/InGaN/InGaN
 - Resin: Silicon (Yellow/White Diffused)
- **Operating Temperature:** -40~+85°C
- Storage Temperature: -40~+100°C
- ESD: 1000V (HBM)
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - CIE Chromaticity/Dominant Wavelength
- Soldering methods: Reflow soldering
- Preconditioning: MSL 5a according to JEDEC
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7")

* In the order of Natural White/Red/Green/Blue.





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	30	mA
Pulse Forward Current (duty 1/10; width 0.1ms)	Імах	70	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	IR	10	μΑ
Electrostatic Discharge (HBM)	ESD	1000	V
Junction Temperature	Tj	110	°C
Soldering Temperature	T _{sol}	260	°C
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т _{stg}	-40~+100	°C



Parameter	Symbol		Values	Unit	Test		
Parameter	Symbol	Min. Typ.		Max.	Unit	Condition	
White - Forward Voltage	VF	2.8		3.4	V	I⊧=20mA	
White- Luminous Intensity	Iv	1300	2200	3700	mcd	I _F =20mA	
White	х		0.3212			L-20mA	
Chromaticity Coordinates	Y		0.3364			l⊧=20mA	
Colour Temperature	ССТ	5710	6020	6530	к	I⊧=20mA	
Red - Forward Voltage	VF	1.9		2.5	V	I⊧=20mA	
Red - Luminous Intensity	Ιv	440	750	1300	mcd	I⊧=20mA	
Red - Wavelength	WP	618		628	nm	l⊧=20mA	
Green - Forward Voltage	VF	2.8		3.4	V	I⊧=20mA	
Green - Luminous Intensity	١v	850	1500	2050	mcd	l⊧=20mA	
Green - Wavelength	WP	520		530	nm	I⊧=20mA	
Blue - Forward Voltage	VF	2.8		3.4	V	I⊧=20mA	
Blue - Luminous Intensity	lv	210	370	620	mcd	I⊧=20mA	
Blue - Wavelength	WP	460		475	nm	I⊧=20mA	
Viewing Angle	20 _{1/2}		120		deg	I _F =20mA	

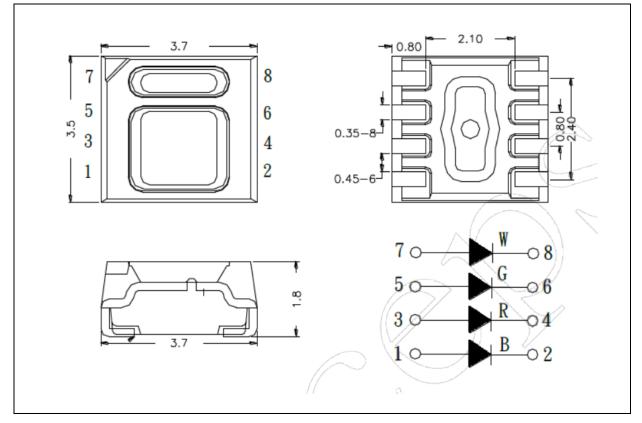
1. Luminous intensity (I_V) ±10%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%, Wavelength (λ) ±1nm.

2. The bin will be amended to maintain bin centralization. The Luminous Intensity will be 1.3 times per bin and the Dominant Wavelength is 5nm per R/G/B bin.



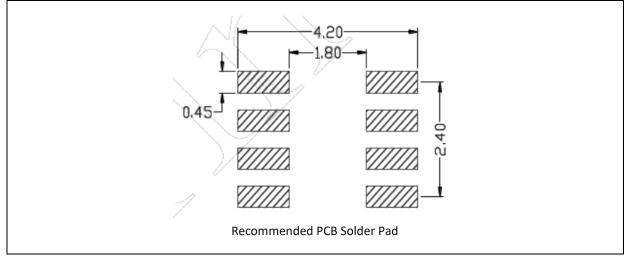
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

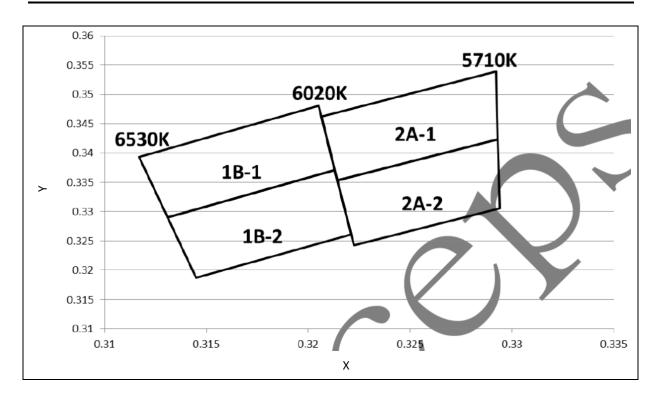
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



CIE CHROMATICITY DIAGRAM (WHITE):

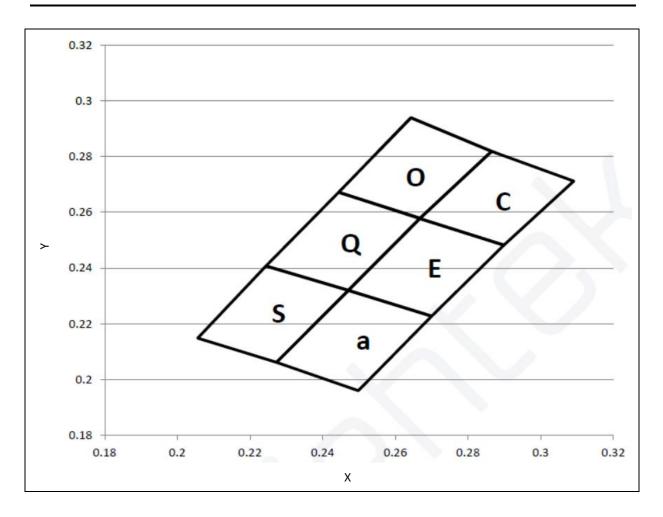


Chromaticity Coordinates Classifications (I_F = 20mA):

		l		2		3		1
	Х	Y	Х	Y	Х	Y	Х	Y
1B-1	0.3205	0.3481	0.3117	0.3393	0.3131	0.3290	0.3213	0.3371
1B-2	0.3213	0.3371	0.3131	0.3290	0.3145	0.3187	0.3221	0.3261
2A-1	0.3292	0.3539	0.3206	0.3462	0.3214	0.3353	0.3293	0.3423
2A-2	0.3293	0.3423	0.3214	0.3353	0.3222	0.3243	0.3294	0.3306



CIE CHROMATICITY DIAGRAM (RGB):

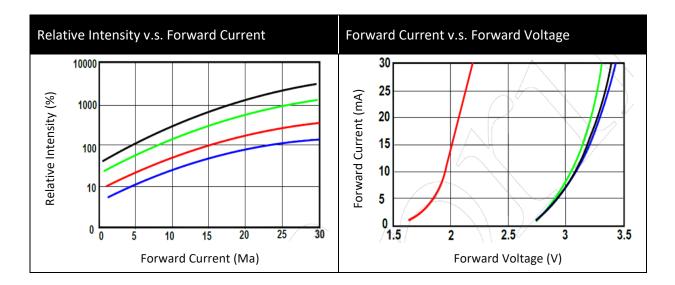


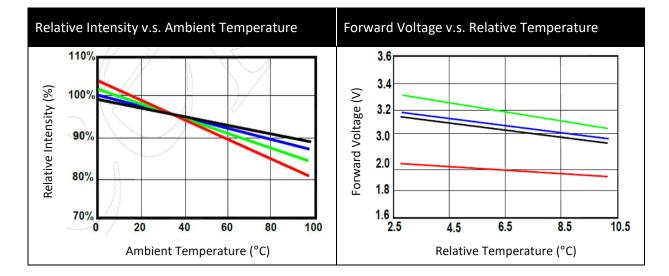
Chromaticity Coordinates Classifications:

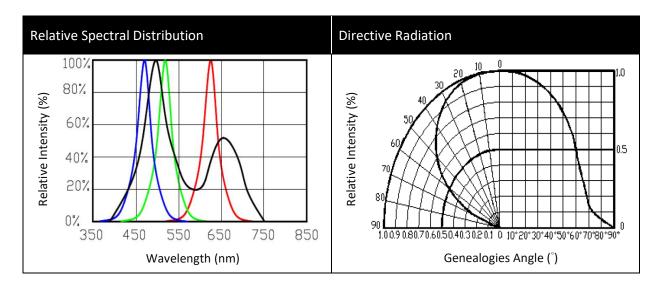
	1		2		3		4	
	Х	Y	х	Y	Х	Y	Х	Y
0	0.2444	0.2672	0.2643	0.2940	0.2865	0.2819	0.2667	0.2578
С	0.2865	0.2819	0.3019	0.2712	0.2899	0.2482	0.2667	0.2578
Q	0.2444	0.2672	0.2244	0.2407	0.2471	0.2320	0.2669	0.2579
E	0.2667	0.2578	0.2899	0.2482	0.2700	0.2227	0.2470	0.2320
S	0.2244	0.2407	0.2056	0.2148	0.2273	0.2061	0.2471	0.2320
а	0.2471	0.2320	0.2273	0.2061	0.2498	0.1959	0.2700	0.2227



ELECTRO-OPTICAL CHARACTERISTICS:

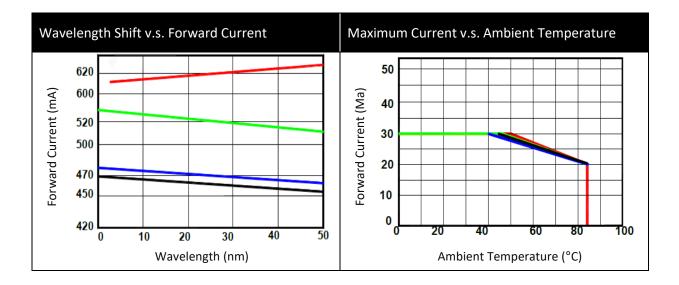








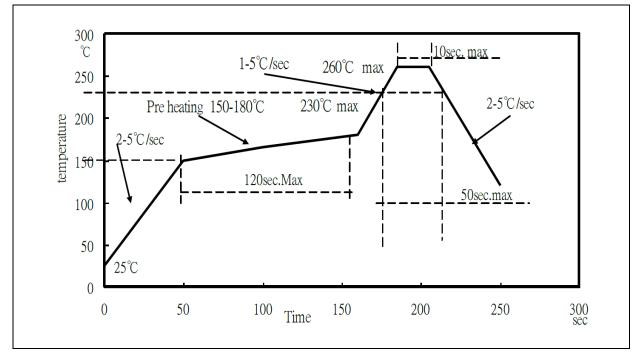
ELECTRO-OPTICAL CHARACTERISTICS:





RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



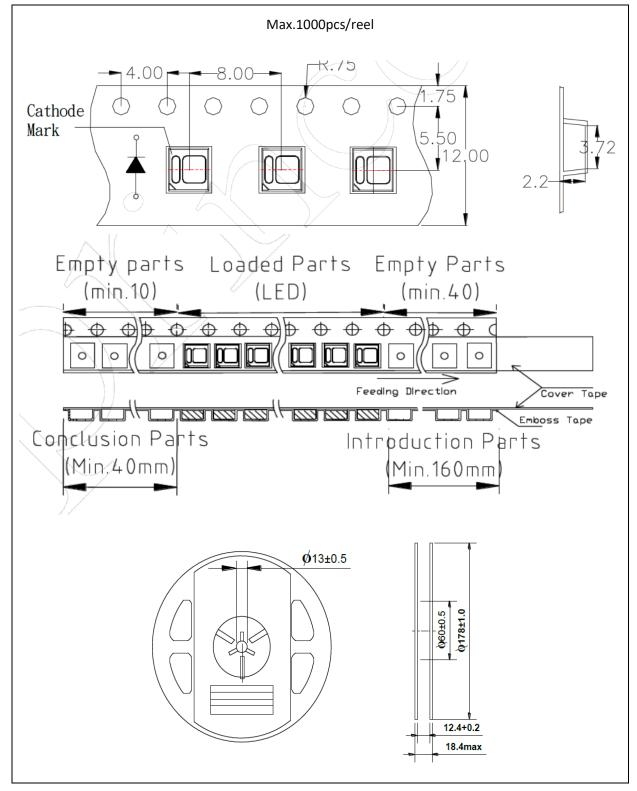
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature is 240°C; the maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 48 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

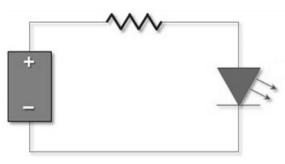
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	03/06/2020	Datasheet set-up.
A1.1	04/06/2022	Revise white lumen level.
A1.2	13/07/2022	Add chromaticity diagram of RGB mix white.